

CubeSat Kit™

Pluggable Processor Module (PPM) A2 Hardware Revision: B

PPM with TI's MSP430F1611 for CubeSat Kit Motherboard

Applications

- CubeSat nanosatellite control, C&DH, TT&C
- General-purpose low-power computing for CubeSat Kit architecture
- Remote sensing for harsh environments

Features

- For CubeSat Kit Motherboard (MB)
- TI's MSP430F1611 16-bit microcontroller (MCU)
- 50KB program memory, 10KB on-chip SRAM
- Integrated peripherals:
 - 2 SCIs (UARTO/SPI0/I2C & UART1/SPI1)
 - 8-channel 12-bit ADC
 - 2-channel 12-bit DAC
 - 16-bit Timer A3
 - 16-bit Timer B7
 - 3-channel DMA
 - On-chip comparator
 - SVS, BOR, WDT, JTAG, etc.
- 7.3728MHz & 32.768kHz clock crystals
- PCA9515A I2C isolator
- Ultra-low power operation
- Independent latchup (device overcurrent) protection
- Independent external reset supervisor (POR/BOR)
- Small-size PPM footprint
- 4-layer gold-plated blue-soldermask PCB
- Compatible with Pumpkin's Salvo[™] RTOS and HCC-Embedded's EFFS-THIN SD Card file FAT file system for ease of programming



ORDERING INFORMATION

Pumpkin P/N 710-00486

Option Code	PPM Connector Height
/00 (standard)	+3mm

Contact factory for availability of optional configurations.

Option code /00 shown.



CAUTION

Electrostatic Sensitive Devices

Handle with Care



CHANGELOG

Rev.	Date	Author	Comments
Α	20090728	AEK	Initial revision.
В	20090808	AEK	Added photo.
С	20100113	AEK	Revised I _{SLEEP} based on lot testing of PCA9515A.

OPERATIONAL DESCRIPTION

PPM A2 enables CubeSat Kit customers to utilize TI's ultralow-power MSP430 processor on a CubeSat Kit Motherboard (MB). PPM A2 uses the 64-pin MSP430F1611IPM, with a wide selection of on-chip peripherals. Additionally, a PCA9515A I2C isolator is present to facilitate I2C interfacing.

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Value	Units
Operating temperature	T_A	-40 to +85	°C
Voltage on +5v_usb bus			
Voltage on +5v_sys bus		-0.3 to +6.0	V
Voltage on -FAULT_OC open-collector output			
Voltage on vcc bus		-0.3 to +3.6	\/
Voltage on vcc_sp bus		-0.3 10 +3.0	V
Voltage on any MSP430 I/O pin		-0.3 to 3.6	V
Diode current at any MSP430 pin		-2 to +2	mA
DC current through any pin of PPM connector H1	I _{PIN_MAX}	1.2	Α
MSP430 operating frequency	$f_{OP\;MAX}$	7.4	MHz

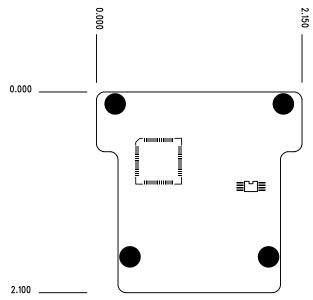
Refer to the MSP430x161x family datasheet for additional absolute maximum ratings associated with processor $\mathtt{U1}$, especially per-pin current limits.

PHYSICAL CHARACTERISTICS

Parameter	Conditions / Notes	Symbol	Min	Тур	Max	Units
Mass				11		g
Height of components above PCB					2	mm
Height of components below PCB ¹					4	mm
PCB width				54.6		mm
PCB length	Small-size PPM			53.4		mm
PCB thickness				1.6		mm

SIMPLIFIED MECHANICAL LAYOUT ²

PPM A2 is implemented on a small-size PPM PCB, as shown below.



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¹ Not including connector H1.

² Dimensions in inches.

ELECTRICAL CHARACTERISTICS

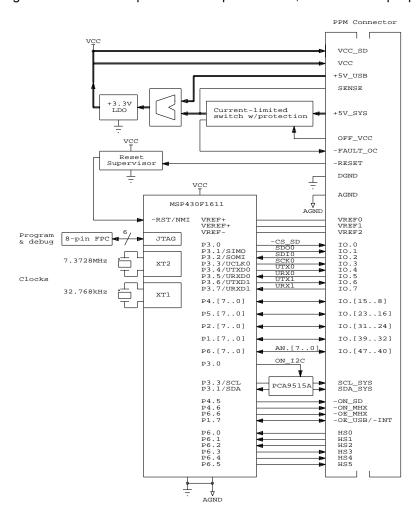
(T = 25°C, +5V bus = +5V unless otherwise noted)

Parameter	Conditions / Notes	Symbol	Min	Тур	Max	Units
Reset voltage	+5v_sys reduced until MCU resets	V _{RESET_MAX}			3.1	V
Operating Voltage		V _{CC}		3.3		٧
SD Card Voltage		V_{CC_SD}		3.3		V
	LPM0, MCLK = DCO	I _{OP}		3		mA
Operating current	LMP4, all control outputs inactive, I2C isolator v5 fitted	I _{SLEEP}	400		1000	μΑ
Low-frequency clock frequency	LFXTAL	f_{CLK_LF}	32	.768 ± 0.0	01	kHz
DCO clock frequency	DCOCLK	$f_{ extsf{CLK DCO}}$	680	760	840	kHz
High-frequency clock frequency	HFXTAL	f_{CLK_HF}	7.3	728 ± 0.0	005	MHz
Overcurrent trip point for vcc	Set by R3	I _{TRIP_VCC}		220		mA
Time to switch between +5v_sys and +5v_usb power sources	Automatic				1	μs

For more information on TI's MSP430 ultralow-power microcontrollers, refer to the TI datasheets.

BLOCK DIAGRAM

PPM A2 provides regulated and current-limited +3.3V power, an external POR/BOR reset supervisor, a JTAG interface for programming and debugging, two clock sources, an external I2C isolator, connections to all 48 I/O pins of the PPM connector, shared MB control and radio handshaking signals, and a single-point analog/digital ground. All of the 64-pin MSP430's pin are used, some for multiple purposes.



PPM PIN DESCRIPTIONS

The PPM connector **H1** connects the PPM to resources residing on the MB and to resources accessible via the CubeSat Kit Bus connector.³

Those signals that are connected directly to the PPM connector and to the CubeSat Kit Bus connectors are tagged under the CSKB label below. Signals marked with an '*' are associated with dedicated peripherals on the MB. Some may also be used with off-board peripherals through the proper use of MB peripheral enables and MB power control.

The *potential* for a pin's function is described by the I/O field. The *recommended usage* (as a digital or analog input or output, or as a power pin) is listed in the Description field. I/O pins can generally be configured as general-purpose I/O if the recommended usage is not desired.

Inputs are signals from the MB to the PPM's processor U1 or other circuitry. Outputs are signals from the PPM's processor U1 or other circuitry to the MB.

	H1 LSS-	150	-01-L-DV	
TO 22	БОО	100	1 IO.47	
IO.23 IO.22	2	1	IO.46	
	4	3	IO.45	
10.21	6	5		
10.20	8	7	IO.44	
IO.19	10	9	IO.43	
IO.18	12	11	IO.42	
IO.17	14	13	IO.41	
IO.16	16	15	IO.40	
10.15	18	17	IO.39	
IO.14	20	19	IO.38	
IO.13	22	21	IO.37	
IO.12	24	23	IO.36	
IO.11	26	25	IO.35	
IO.10	28	27	IO.34	
IO.9	30	29	IO.33	
IO.8	32	31	IO.32	
IO.7 *	34	33	IO.31	
IO.6 *	36	35	IO.30	
IO.5	38	37	IO.29	
IO.4	40	39	IO.28	
IO.3 *	42	41	IO.27	
IO.2 *	44	43	IO.26	
IO.1 *	46	45	IO.25	
IO.0 *	48		IO.24	
+5V_USB	48 50	47 49	+5V_USB	
+5V SYS			+5V_SYS	
VCC SD	52	51	VCC SD	
VCC	54	53	VCC	
DGND	56	55	DGND	
AGND	58	57	AGND	
VBATT	60	59	VBATT	
VBACKUP	62	61	VBACKUP	
VREF0	64	63	* -FAULT OC	<
VREF1	66	65	SENSE	<
VREF2	68	67	-RESET	>
	70	69	OFF VCC	>
×	72	71	SDA SYS	<->
×	74	73	SCL SYS	<
×	76	75	_	
×	78	77	⊢–×	
> -ON SD **	80	79	 ×	
> -ON MHX *	82	81	⊢ ×	
> -OE MHX *	84	83	 ×	
> -OE USB/-INT *	86	85	 ×	
< HSO *	88	87	⊢ ×	
< HS1 *	90	89	⊢ ×	
< HS2 *	92	91	⊢ ×	
> HS3 *	94	93	├ ─×	
> HS4 *	96	95	<u></u>	
> HS5 *	98	97	<u></u>	
_ 1100	100	99		
· ·			ı	

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 $^{^{3}}$ Not included. MBs are purchased separately from PPMs.

⁴ The CubeSat Kit's system peripherals are numbered from 0 onwards (e.g., U0, SPI0, etc.), and this nomenclature is used when referring to a PPM or CSK bus signal. The MSP430's peripheral nomenclature begins with 0 (e.g., UART0, SPI0, etc.), and is used when referring to peripherals, signals and registers internal to the MSP430.

PPM PIN DESCRIPTIONS - I/O

Nome				Description
Name	Pin	I/O	CSKB	Description GR. GR. (OX. TOG. Controls SD. Cord interface and ISC.
				-Cs_sD/ON_I2C. Controls SD Card interface and I2C
10.0	H1.48	I/O	•	isolator. From P3.0 (U1.28). Part of the MB's SD card interface and the PPM's I2C isolator. P3.0 is normally
				configured as a simple digital output.
				spoo. SPI0 (master) data out. From p3.1/simoo (u1.29).
				Part of the MB's SD card interface. P3.1/SIMO0 is normally
10.1	H1.46	I/O	•	configured as a digital output as part of USART0:SPI when
				the SPI peripheral is active.
				SDIO. SPIO (master) data in. To P3.2/SOMIO (U1.30). Part
10.2	H1.44	I/O		of the MB's SD card interface. P3.2/SOMIO is normally
10.2	H1.44	1/0	•	configured as a digital input as part of USART0:SPI when the
				SPI peripheral is active.
				SCKO. SPIO clock. From P3.3/UCLKO (U1.31). Part of the
10.3	H1.42	I/O	•	MB's SD card interface. P3.3/UCLKO is normally configured
				as a digital output as part of USART0:SPI when the SPI
				peripheral is active.
TO 4	Ц4.40	1/0		UTX0. Tx0 data out. From P3.4/UTXD0 (U1.32).
10.4	H1.40	I/O	•	P3.4/UTXD0 is normally configured as a digital output as part of USART0:UART when the UART peripheral is active.
_				URXO. RxO data in. To P3.5/URXDO (U1.33). P3.5/URXDO is
10.5	H1.38	I/O	•	normally configured as a digital input as part of
1013	111.50	"		USARTO:UART when the UART peripheral is active.
				UTX1. Tx1 data out. From P3.6/UTXD1 (U1.34). Part of the
- 0.6	114.00	1/0	_	MB's MHX/USB interface. P3.6/UTXD1 is normally
10.6	H1.36	I/O	•	configured as a digital output as part of USART1:UART when
				the UART peripheral is active.
				URX1. Rx1 data in. To P3.7/URXD1 (U1.35). Part of the MB's
10.7	H1.34	I/O	•	MHX/USB interface. P3.7/URXD1 is normally configured as
	111.01	., 0		a digital input as part of USART1:UART when the UART
	114.00	1/0		peripheral is active.
10.8	H1.32	I/O	•	General-purpose I/O. To/from P4.0 (U1.36).
10.9	H1.30	I/O	•	General-purpose I/O. To/from P4.1 (U1.37).
IO.10	H1.28	I/O	•	General-purpose I/O. To/from P4.2 (U1.38).
10.11	H1.26	I/O	•	General-purpose I/O. To/from P4.3 (U1.39).
10.12	H1.24	I/O	•	General-purpose I/O. To/from P4.4 (U1.40).
TO 13	114.00	1/0		-ON_SD. MB control signal. From P4.5 (U1.41). Part of the
10.13	H1.22	I/O	•	MB's SD card interface. P4.5 is normally configured as a
				digital output. See -on_sd signal description, below. -on mhx. MB control signal. From p4.6 (U1.42). Part of the
10.14	H1.20	I/O	•	MB's MHX interface. P4.6 is normally configured as a digital
10.14	111.20	1/0		output. See -on_mhx signal description, below.
10.15	H1.18	I/O	•	General-purpose I/O. To/from P4.7 (U1.43).
10.16	H1.16	I/O	•	General-purpose I/O. To/from P5.0 (U1.44).
10.17	H1.14	1/0	•	General-purpose I/O. To/from P5.1 (U1.45).
10.18	H1.12	1/0	•	General-purpose I/O. To/from P5.1 (01.45). General-purpose I/O. To/from P5.2 (U1.46).
10.19	H1.10	1/0	•	General-purpose I/O. To/from P5.2 (U1.47).
10.20	H1.8	I/O	•	General-purpose I/O. To/from P5.4 (U1.48).
10.21	H1.6	I/O	•	General-purpose I/O. To/from P5.5 (U1.49).
10.22	H1.4	I/O	•	General-purpose I/O. To/from P5.6 (U1.50).
10.23	H1.2	I/O	•	General-purpose I/O. To/from P5.7 (U1.51).
10.24	H1.47	I/O	•	General-purpose I/O. To/from P2.0 (U1.20).
10.25	H1.45	I/O	•	General-purpose I/O. To/from P2.1 (U1.21).
10.26	H1.43	I/O	•	General-purpose I/O. To/from P2.2 (U1.22).
10.20	111.40	1/0		Ochoral-purpose 1/O. 10/110111 P2.2 (01.22).

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10.27	H1.41	I/O	•	General-purpose I/O. To/from P2.3 (U1.23).
10.28	H1.39	I/O	•	General-purpose I/O. To/from P2.4 (U1.24).
10.29	H1.37	I/O	•	General-purpose I/O. To/from P2.5 (U1.25).
10.30	H1.35	I/O	•	General-purpose I/O. To/from P2.6 (U1.26).
10.31	H1.33	I/O	•	General-purpose I/O. To/from P2.7 (U1.27).
10.32	H1.31	I/O	•	General-purpose I/O. To/from P1.0 (U1.12).
10.33	H1.29	I/O	•	General-purpose I/O. To/from P1.1 (U1.13).
10.34	H1.27	I/O	•	General-purpose I/O. To/from P1.2 (U1.14).
10.35	H1.25	I/O	•	General-purpose I/O. To/from P1.3 (U1.15).
10.36	H1.23	I/O	•	General-purpose I/O. To/from P1.4 (U1.16).
10.37	H1.21	I/O	•	General-purpose I/O. To/from P1.5 (U1.17).
10.38	H1.19	I/O	•	General-purpose I/O. To/from P1.6 (U1.18).
10.36	піля	1/0		
				-OE_USB/-INT. MB control/status signal. To/from P1.7
10.39	H1.17	I/O	•	(U1.19). Part of the MB's USB and RTC interfaces. P1.7 is
				normally configured as a digital output. See -oE_USB and
				-INT signal descriptions, below.
				AN.0/HS0. Analog input or MB handshake signal. To/from
				P6.0 (U1.59). Part of the MB's MHX interface. P6.0 is
10.40	H1.15	I/O	•	normally configured as a digital input. See нѕо signal
				description, below. Can also be used as a general-purpose
				I/O or an analog input.
				AN.1/HS1. Analog input or MB handshake signal. To/from
				P6.1 (U1.60). Part of the MB's MHX interface. P6.1 is
10.41	H1.13	I/O	•	normally configured as a digital input. See нs 1 signal
				description, below. Can also be used as a general-purpose
				I/O or an analog input.
				AN.2/HS2. Analog input or MB handshake signal. To/from
				P6.2 (U1.61). Part of the MB's MHX interface. P6.2 is
10.42	H1.11	I/O	•	normally configured as a digital input. See нs2 signal
				description, below. Can also be used as a general-purpose
				I/O or an analog input.
				AN.3/HS3. Analog input or MB handshake signal. To/from
				P6.3 (U1.2). Part of the MB's MHX interface. P6.3 is
10.43	H1.9	I/O	•	normally configured as a digital output. See HS3 signal
				description, below. Can also be used as a general-purpose
				I/O or an analog input.
				AN.4/HS4. Analog input or MB handshake signal. To/from
				P6.4 (U1.3). Part of the MB's MHX interface. P6.4 is
10.44	H1.7	I/O	•	normally configured as a digital output. See HS4 signal
				description, below. Can also be used as a general-purpose
				I/O or an analog input.
				AN.5/HS5. Analog input or MB handshake signal. To/from
				P6.5 (U1.4). Part of the MB's MHX interface. P6.5 is
10.45	H1.5	I/O	•	normally configured as a digital output. See HS5 signal
				description, below. Can also be used as a general-purpose
				I/O or analog input.
				AN.6/-OE_MHX. Analog input or MB control signal. To/from
				P6.6 (U1.5). Part of the MB's MHX interface. P6.6 is
10.46	H1.3	I/O	•	normally configured as a digital output. See -oe_mex signal
	''''	"		description, below. Can also be used as general-purpose I/O
				or an analog output.
		+		AN.7. Analog input. To/from P6.7 (U1.6). Can also be used
IO.47	H1.1	I/O	•	as a general-purpose I/O or an analog output.
				as a general-purpose I/O or all allalog output.

PPM PIN DESCRIPTIONS – Power

Name	Pin	I/O	CSKB	Description
+5V_USB	H1.49 H1.50	_	•	+5V USB power. From USB host. Powers PPM.
+5V_SYS	H1.51 H1.52	_	•	+5V system power. From EPS or external +5V connector. Powers PPM.
VCC_SD	H1.53 H1.54	_		+3.3V SD Card power. From PPM's vcc.
vcc	H1.55 H1.56	_		+3.3V PPM power, MB power and I/O level. From PPM LDO u4 using +5v_sys and/or +5v_usb.
DGND	H1.57 H1.58	_	•	Digital ground.
AGND	H1.59 H1.60	ı	•	Analog ground.
VBATT	H1.61 H1.62	_	•	Not connected.
VBACKUP	H1.63 H1.64	_	•	Not connected.

PPM PIN DESCRIPTIONS – Analog References

Name	Pin	I/O	CSKB	Description
VREF0	H1.66	_	•	Positive analog voltage reference. To/from vref+ (u1.7).
VREF1	H1.68	_	•	Positive analog voltage reference. To/from veref+ (u1.10).
VREF2	H1.70	_	•	Negative analog voltage reference. To/from vref- (u1.11).

PPM PIN DESCRIPTIONS - Reserved

Name	Pin	1/0	CSKB	Description
RSVD0	H1.72	_	•	Not connected. Reserved for future use.
RSVA1	H1.74	_	•	Not connected. Reserved for future use.
RSVD2	H1.76	_	•	Not connected. Reserved for future use.

PPM PIN DESCRIPTIONS - MB-Specific

Name	Pin	I/O	CSKB	Description
CB4	H1.78			Not connected.
USBDP	111.76	'		Not connected.
CB2	114.00			Not approved all
USBDM	H1.80	I		Not connected.
-ON_SD	H1.82	0		Control signal for SD Card power. From P4.5 (U1.41). Active LOW, pulled high on the MB. When active, enables VCC_CARD on the MB, thereby powering SC Card socket and SD Card level translators / isolators. Normally configured as a digital output.
-ON_MHX	H1.84	0		Control signal for MHX socket power. From P4.6 (U1.42). Active LOW, pulled high on the MB. When active, enables PWR_MHX on the MB, thereby powering MHX socket and MHX level translators / isolators. Normally configured as a digital output.
-OE_MHX	H1.86	0		Control signal for MHX interface. From P6.6 (U1.5). Active LOW, pulled high on the MB. When active, enables signals to pass through MHX level translators / isolators. Normally configured as a digital output.
-OE_USB	H1.88	0		Control signal for USB interface. From P1.7 (U1.19). Active LOW, pulled high on the MB. When active, enables signals to pass through USB level translators / isolators. Normally configured as a digital output.

-INT		I	Output from RTC's -IRQ open-collector output. To P1.7 (U1.19). When properly configured, can be used to interrupt processor U1 via MB RTC. Normally configured as a digital input.	
HS0	H1.90	I	Handshake signalRTS (USB) or -CTS (MHX). To P6.0 (U1.59). Normally configured as a digital input. Requires that R10 be fitted on the MB.	
HS1	H1.92	I	Handshake signalDTR (USB) or -DSR (MHX). To P6.1 (U1.60). Normally configured as a digital input. Requires that R11 be fitted on the MB.	
HS2	H1.94	I	Handshake signalPWE (USB) or -DCD (MHX). To P6.2 (U1.61). Normally configured as a digital input. Requires that R12 be fitted on the MB.	
нѕз	H1.96	0	Handshake signalCTS (USB) or -RTS (MHX). From P6.3 (U1.2). Normally configured as a digital output. Requires that R75 be fitted on the MB.	
HS4	H1.98	0	Handshake signalRI (USB) or -DTR (MHX). From P6.4 (U1.3). Normally configured as a digital output. Requires that R76 be fitted on the MB.	
HS5	H1.100	0	Handshake (reset) signalRST (USB) or -RST (MHX). From P6.5 (U1.4). Normally configured as a digital output. Requires that R77 be fitted on the MB.	

PPM PIN DESCRIPTIONS - Control & Status

Name	Pin	I/O	CSKB	Description	
-FAULT_OC	H1.65	0		Open-collector output from PPM's latchup prevention overcurrent switch. Active LOW. Wire-ORed to -FAULT_OC on the MB.	
SENSE	H1.67	_	 Can be used to measure PPM's current consumption. Th current used by the PPM from a single source is (source sense) / 75mΩ. Depends on PPM implementation. 		
-RESET	H1.69		Reset signal to PPM's reset supervisor. Active LOW.		
OFF_VCC	H1.71	Ī	Control signal to PPM's power circuit(s). Active HIGH.		

PPM PIN DESCRIPTIONS - I2C Bus

Name	Pin	I/O	CSKB	Description		
SDA_SYS	H1.73	I/O	•	I2C data. To/from P3.1/SDA (U1.29) through I2C isolator U when ON_I2C is active. Part of the I2C interface. SDA is normally configured as an I2C data input/output as part of USART0:I2C when the I2C peripheral is active.		
SCL_SYS	H1.75	0	•	I2C clock. From P3.3/SCL (U1.31) through I2C isolator U5 when ON_I2C is active. Part of the I2C interface. SCL is normally configured as an I2C clock output as part of USARTO:I2C when the I2C peripheral is active.		

PPM PIN DESCRIPTIONS – User-defined

Name	Pin	I/O	CSKB	Description			
USER0	H1.77	I/O	•	Not connected.			
USER1	H1.79	I/O	•	Not connected.			
USER2	H1.81	I/O	•	Not connected.			
USER3	H1.83	I/O	•	Not connected.			
USER4	H1.85	I/O	•	Not connected.			
USER5	H1.87	I/O	•	Not connected.			
USER6	H1.89	I/O	•	Not connected.			
USER7	H1.91	I/O	•	Not connected.			

USER8	H1.93	I/O	•	Not connected.
USER9	H1.95	I/O	•	Not connected.
USER10	H1.97	I/O	•	Not connected.
USER11	H1.99	I/O	•	Not connected.

SHARED I/O PINS

All of U1's I/O pins are connected directly to the CubeSat Kit Bus. Due to the relatively low pincount of the MSP430F1611 used on PPM A2, some of the general-purpose I/O pins are also connected to other signals on PPM connector H1. Generally speaking, these shared I/O pins are dedicated to ancillary functions and should not be used by modules on the CubeSat Kit Bus. Provisions are in place to "free" some of these shared I/O pins from their ancillary functions, as outlined below.

Pin	Signal	Standalone Function	Ancillary Function	Notes
P1.7	-OE_USB/-INT	-OE_USB, -INT	I/O	Always connected to USB interface. Pulled up via 100kΩ to vcc on the MB. Can be isolated from RTC by removal of R73 on the MB. Can be used as simple I/O if VCC_IO is not present on the MB ⁵ and RTC on the MB is configured to ignore -OE_USB/-INT.
P4.5	-on_sd	-ON_SD	none	Always connected to SD Card interface. Pulled up via $100k\Omega$ to vcc on the MB. Arbitration with u1 can permit other devices to control the MB's SD Card interface.
P4.6	-ON_MHX	-ON_MHX	I/O	Always connected to MHX power switching. Pulled up via 100kΩ to vcc on the MB. Arbitration with v1 can permit other devices to power an MHX transceiver on the MB. Can be used as I/O if no source of power is available on the MB to power MHX socket.
P6.0	HS0	HSO	I/O, analog input	When R10 on the MB is fitted, to be used as a handshake line to USB or MHX. When R10 on the MB is <i>not</i> fitted, to be used as analog input or digital I/O.
P6.1	HS1	HS1	I/O, analog input	When R11 on the MB is fitted, to be used as a handshake line to USB or MHX. When R11 on the MB is <i>not</i> fitted, to be used as analog input or digital I/O.
P6.2	HS2	HS2	I/O, analog input	When R12 on the MB is fitted, to be used as a handshake line to USB or MHX. When R12 on the MB is <i>not</i> fitted, to be used as analog input or digital I/O.
P6.3	HS3	нs3	I/O, analog input	When R75 on the MB is fitted, to be used as a handshake line to USB or MHX. When R75 on the MB is <i>not</i> fitted, to be used as analog input or digital I/O.
P6.4	HS4	HS4	I/O, analog input	When R76 on the MB is fitted, to be used as a handshake line to USB or MHX. When R76 on the MB is <i>not</i> fitted, to be used as analog input or digital I/O.
P6.5	нѕ5	HS5	I/O, analog input	When R77 on the MB is fitted, to be used as a handshake line to USB or MHX. When R77 on the MB is <i>not</i> fitted, to be used as analog input or digital I/O.

⁵ I.e., if USB is not connected.

5

P6.6	-ое_мнх	-ОЕ_МНХ	I/O	Always connected to MHX interface. Pulled up via 100kΩ to vcc on the MB. Can be used as an analog input, analog output or simple I/O when ppwr_mhx on the MB is off.
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For example, if -on_MHX is kept inactive, DPWR_MHX on the MB is off. Therefore MB MHX isolators U2 and U3 are left in a high-impedance state, and P6.[7..0] can all be used as analog inputs, getting their signals from the CubeSat Kit Bus via IO.[47..40]. This is true regardless of the state of the resistors R10-R12 and R75-R77 on the MB. For further information, consult the PPM A2 and MB schematics.

12C ISOLATOR

On PPM A2, U5 is an I2C bus isolator implemented via a PCA9515A. The purpose of U5 is to ensure that the I2C peripherals attached to the I2C bus via SCL_SYS and SDA_SYS do not see spurious clock and/or data signals when SPI activity is present on SPI0, which might cause problems with the I2C bus. I2C signals to/from U1 can only reach the I2C bus when ON_I2C is active. Therefore, when ON_I2C is inactive, U1 can perform SPI activity on SPI0 (e.g., read from and write to the SD Card on the MB) without fear of I2C bus problems.

 ${u}$ 5 has a quiescent current consumption I_{SLEEP} of around 500μA, regardless of the state of on_i2c. This sets the floor for I_{SLEEP} . Users not requiring I2C connectivity, or wishing to implement an I2C isolator elsewhere in the system, can remove ${u}$ 5, thereby reducing I_{SLEEP} to under 40μA.

CONNECTORS

Item	Description	Source	Part Number	Application
1	100-pin, hermaphroditic	Samtec	LSS-150-01-L-DV	PPM connector (standard, +3mm)

This connector information is provided for reference only.

PROGRAMMING & DEBUGGING

PPM A2 provides one interface for programming and debugging – the popular and low-cost Flash Emulation Tool (FET) interface, a type of JTAG interface. It is implemented via Flexible Printed Circuit (FPC) connector on the PPM.

8-pin FPC connector **J1** is for the FET. Via Pumpkin's JFPC-MSP430 adapter, customers can connect either a traditional TI USB or parallel FET, or an aftermarket FET, all with 14-pin 2x7 0.100" pitch dual-inline headers. The JFPC-MSP430 connects to PPM A2 via an 8-conductor FPC cable.

NOTES

PPM A2 (MSP430F1611) is built on the same Pumpkin PCB (705-00378) as PPM A1 (MSP430F1612) and PPM A3 (MSP430F2618), with minor differences in the components placed at assembly time.

⁶ Even if an analog signal drives P6.6 (-OE_MHX) below the input threshold of U1 or U2, the isolators remain in their high-impedance state because DFWR_MHX (enabled via -ON_MHX) is off.

⁷ I_{SLEEP} of 40μA is representative of the quiescent current of the previous-generation FM430 flight module, of which the MB + PPM A2 combination is a superset.

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